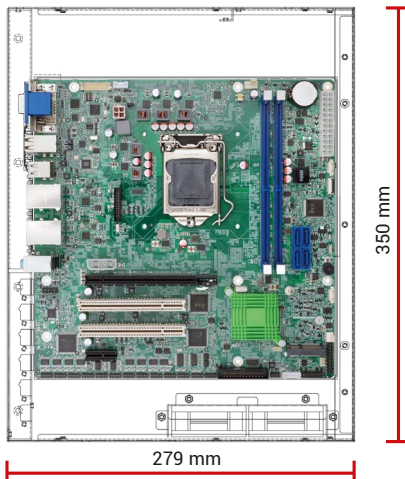


PC Industriali

Serie GO-B02 - Chassis Book-mount per motherboard



PC Book-mount
 Sei slot Low Profile
 Soluzione Front I/O
 Configurato su richiesta
 Burn in climatico su ogni apparato
 Test Report di collaudo



Chassis

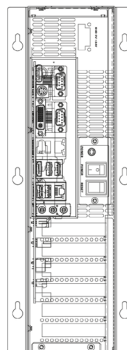
IP-352- Rev.7

Dimensioni	Chassis - 350(A) x 88(L) x 279(P) mm
Montaggio	Book-mount (staffe incluse) e Desktop
Materiale	Acciaio pre-zincato
Architettura	Motherboard 9.6" x 9.6", schede low profile
Varianti	GOB-B02: Chassis Book-mount colore nero
Drives	Lettore Cfast opzionale
Ventilazione	2 x ventole PWM 60mm
Led sul fronte	LED per Power On/Off e funzionalità HDD
Pulsanti	Power On/Off e System Reset
Fronte	I/O shield motherboard e bracket schede integrate
Alimentazione	Alimentatore 24VDC - Power input frontale Versione AC su richiesta
Slot di espansione	6 slot low profile
Colore	Nero o altri colori su richiesta
Shock	5G durata 11ms - EN 60068-2-27
Vibrazioni	10-150Hz: 1G - EN 60068-2-6
Umidità	10 - 95% non condensata
Temperatura	Operativa 0°C... +50°C Storage -20°C... +70°C

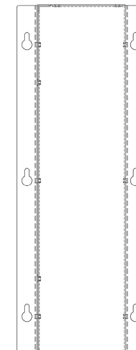
Complementi

Storage	<ul style="list-style-type: none"> • Disk on Module • Modulo CFAST estraibile • M.2 Interface: 1 PCI-E 3.0 x4 NVMe • M.2 Form Factor: 2242/2280 • M.2 Key: M-Key
Media	<ul style="list-style-type: none"> • Tastiera beige/nera italiana/inglese • Mouse ottico
Schede I/O	<ul style="list-style-type: none"> • Ethernet Server Adapter • GPGPU / Schede Video • Schede Multi-Head • Schede I/O Analogiche e Digitali • Schede FPGA • Schede MULTISERIALI • Frame Grabber • MIL-1553 / ARINC 429 / ARINC 418
Sistemi Operativi	<ul style="list-style-type: none"> • Windows® versioni Enterprise / Embedded • Windows® versioni Server • Linux

Fronte



Retro



Motherboard



IMB-H110



IMB-Q870-i2

CPU Preferred	<ul style="list-style-type: none"> • i7-7700: 4C 3.6GHz, 65W • i7-6700: 4C 3.4GHz, 65W • i5-6500: 4C 3.2GHz, 65W • i3-6100: 2C 3.7GHz, 51W 	<ul style="list-style-type: none"> • i7-4770S: 4C 3.1GHz, 65W • i5-4570S: 4C 2.9GHz, 65W • i3-4330: 2C 3.5GHz, 54W
Chipset	Intel H110	Intel Q87
RAM	DDR4 - 2133, 2 x DIMM, max. 64GB	DDR3 - 1600/1333, 4 x DIMM, max. 32GB
Graphics	VGA, DVI-I, LVDS, iDP	VGA, DVI-D, HDMI, iDP
Ethernet	2 GbE	2 GbE
SATA ports	4 x SATA 600	4 x SATA 600 (support RAID 0,1,5,10)
M.2 ports	--	--
USB	8 x USB 2.0/ 4 x USB 3.0	8 x USB 2.0/ 4 x USB 3.0
COM	10 x RS-232 2 x RS 232/422/485	5 x RS-232 1 x RS 422/485
Other	Audio, PS2	Audio, PS2
Expansion slots	1*PCI-E x16, 1*PCI-E Mini card, 1*PCI-E x1, 2 x PCI	1*PCI-E x16 (Gen 3), 1*PCI-E x1, 1*PCI-E x4, 1 x PCI
I/O shield	4 x USB 3.0, 6 x USB 2.0, 1 x VGA, 1 x DVI-I, 2 x LAN, Audio	1 x PS2, 6 x USB, 1 x RS232, 1 x HDMI, 1 x VGA, 1 x DVI-D, 2 x LAN, Audio

Alimentatori

DC



EN 62368

Z-FSP250-52FGB
250W FLEX

		Output				
+3.3V	+5V	+12V	-5V	-12V	+5VSB	
10A	14A	18A	-	0.3A	2.5A	
Input		-18 ~ 36 VDC				
MTBF		100.000 h				
Dimensioni		81.5x40.5x150 mm				

